

PRODUCT PROGRAM

MODEL SELECTION

QF^①05^②03^③X^④MS^⑤

- ① Product Series
- ② Input Voltage
- ③ Output Voltage
- ④ Fixed Input
- ⑤ SIP4 Package

PRODUCT PROGRAM						

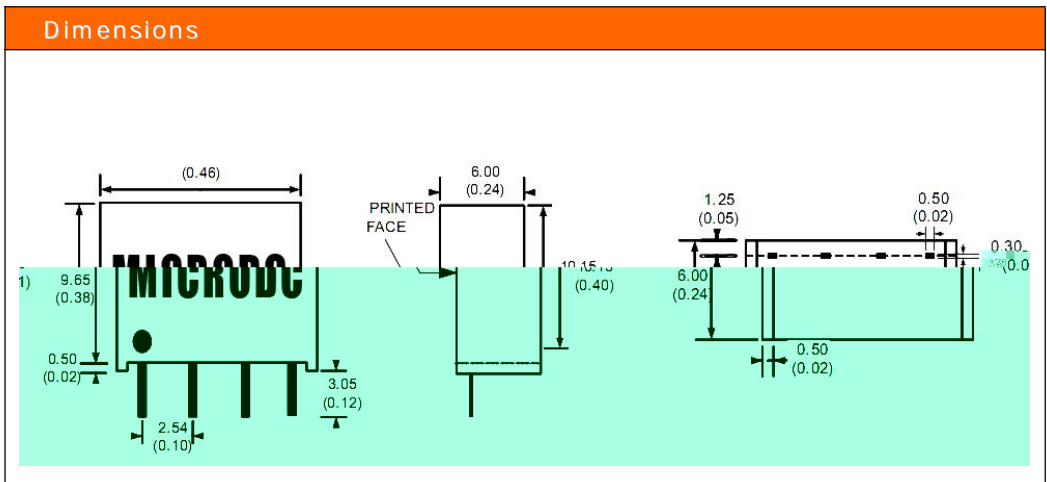
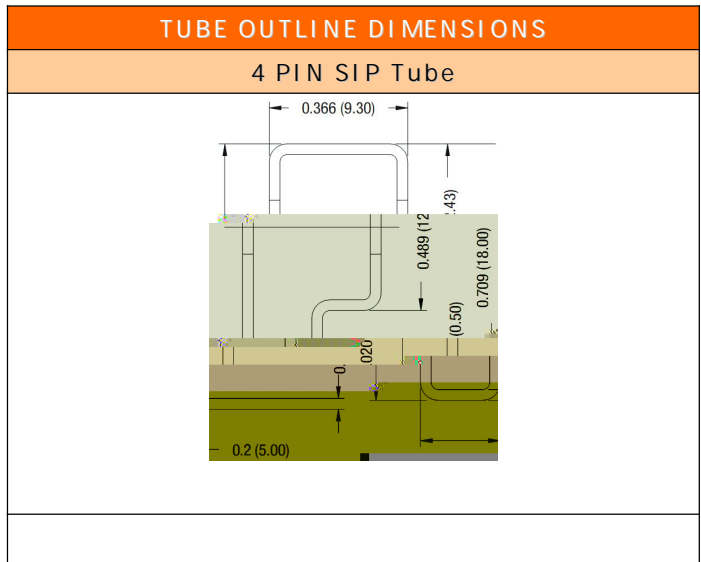
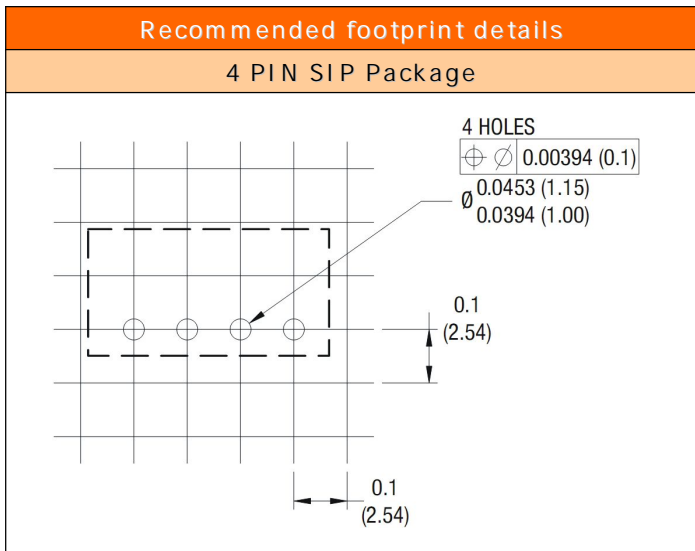


Input Specifications				
Parameters	Nominal	Typical	Maximum	Units
		-		

General Specifications				
			~	°C
			~	°C
				°C
				°C

Output Specifications				

Isolation Specifications				
Parameters	Conditions	Typical	Rated	Units



Pin Out Specifications

Pin	Single



This series is compatible with RoHS soldering systems with a peak wave solder temperature of 300°C for 10 seconds. The pin termination finish on the SIP package type is Tin Plate, Hot Dipped over Matte Tin with Nickel Preplate. The DIP types are Matte Tin over Nickel Preplate. Both types in this series are backward compatible with Sn/Pb soldering systems.



This series has proven that this product does not contain harmful chemicals, it also has harmful chemical substances through the registration, inspection and approval.